#### **TIDA-00275 TPS65320EVM BOM**

Quantity	Reference Designator	Description	Manufacturer	Part Number
2	BUCK_EN, LDO_EN	HEADER,THU,1x3,2.54mm	FISCHER	SL LP 1 097 3 G
2	C19, C20	CAPACITOR,SMT,CER, 47uF,25V,20%,X7S	TDK	CKG57NX7S1E476M
1	C5	CAPACITOR,SMT,0603,CERAMIC,0.0022uF,50V,5%,X7R	AVX	06035C222JAT2A
1	C3	CAPACITOR,SMT,0603,CERAMIC,10pF,50V,5%,COG(NPO)	KEMET	C0603C100J5GAC
1	C4	CAPACITOR,SMT,0603,CERAMIC,100pF,50V,5%,COGR	KEMET	C0603C101J5GAC
2	C12, C13	CAPACITOR,SMT,0603,CERAMIC,0.1uF,50V,10%,X7R	KEMET	C0603C104K5RAC
1	C2	CAPACITOR,SMT,0603,CERAMIC,X7R,0.0047uF,50V,5%	KEMET	C0603C472J5RAC
1	C1	CAPACITOR,SMT,0805,CERAMIC,10uF,16V,10%,X5R	TAIYO YUDEN	EMK212BJ106KG
1	C21	CAPACITOR,SMT,0805,CERAMIC,1.0uF,50V,10%,X7R	MURATA	GRM21BR71H105KA12L
1	C11	CAPACITOR,SMT,1210,CERAMIC,2.2uF,100V,10%,X7R	KEMET	C1210C225K1RAC
1	C8	CAPACITOR,SMT,2P,ELEC,100uF,63V,20%,-40~125C	PANASONIC	EEE-TG1J101UP
0	C10	UNINSTALLED CAPACITOR,SMT,2P,ELEC,47uF,63V,20%,-40~125C	PANASONIC	EEETG1J470P (UN)
2	D1, D2	SCHOTTKY BARRIER RECTIFIER,SMT,40V,4A	VISHAY	SL44-E3/57T
1	U1	POWERMANAGEMENT IC, SMT, HTSSOP, 14P	TI	TPS65320QPWPRQ1
1	L1	INDUCTOR,SMT,10uH,20%,5.8A, SHIELD	EPCOS	B82477P4103M000
4	J2, J3, J4, J5	JUMPER,SMD,2P,2.54	FISCHER	SL 11 SMD 062
2	R4, R5	RESISTOR,SMT,0603,1%,1/10W,100k	VISHAY	CRCW0603100KF
1	R9	RESISTOR,SMT,0603,1%,1/10W,1.20M	VISHAY	CRCW06031M20F
1	R6	RESISTOR,SMT,0603,1%,1/10W,20.0k	VISHAY	CRCW060320K0F
1	R8	RESISTOR,SMT,0603,1%,1/10W,300k	VISHAY	CRCW0603300KF
1	R3	RESISTOR,SMT,0603,1%,1/10W,316k	VISHAY	CRCW0603316KF
1	R13	RESISTOR,SMT,0603,1%,1/10W,3.90k	VISHAY	CRCW06033K90F
1	R7	RESISTOR,SMT,0603,1%,1/10W,49.9k	VISHAY	CRCW060349K9F
2	R1, R2	RESISTOR,SMT,0603,1%,1/10W,49.9	VISHAY	CRCW060349R9F
1	R12	RESISTOR,SMT,0603,1%,1/10W,523k	VISHAY	CRCW0603523KF
6	BUCK_GND, BUCK_OUT, LDO_GND,	TEST POINTS,THU	MILL-MAX	2505-2-00-44-00-00-07-0
	LDO_OUT, VBAT, VBAT_GND			
1	TP_VIN_LDO	CONN HEADER .100 SINGL STR 2POS	SULLINS	PEC02SAAN
10	TP_FB1, TP_FB2, GND,	TESTPOINT,THU,MINIATURE,0.1LS,120TL, WHITE	KEYSTONE	5002
	TP_BUCK_OUT, TP_BUCK_PM,			
	TP_LDO_GND, TP_LDO_OUT,			
	TP_LDO_PM, TP_SW, TP_nRST			
6	BUCK_EN, LDO_EN, J2-J5	2.54mm JUMPER	FISCHER	CAB 4 G S
1	РСВ	PCB	TPS65320EVM_PCB	ANY

#### TIDA-00275 TLV62065EVM-719 BOM

Quantity	Reference Designator	Description	Manufacturer	Part Number
2	C1, C2	Capacitor, Ceramic, 10uF, 6.3V, X5R, 20%	muRata	GRM188R60J106ME47D
0	C3	Open, Capacitor, Ceramic, 6.3V, X5R, 20%	Std	Std
1	C4	Capacitor, Ceramic, 22uF, 10V, X5R, 20%	muRata	GRM32ER71A226K
1	C5	Capacitor, Ceramic, 22pF, 50V, NPO, 5%	Std	Std
6	J1, J2, J3, J4, J5, J6	Header, Male 2-pin, 100mil spacing	Sullins	PEC02SAAN
0	J7	Open, Connector, SMA, Straight, PC mount	AMP	901-144-8RFX
2	JP1, JP2	Header, 3 pin, 100mil spacing	Sullins	PEC03SAAN
1	L1	Inductor, SMT, 1.2uH, 3.1A, ±30%	Taiyo Yuden	NRG4026T-1R2N
1	R1	Resistor, Chip, 1/16W, 1%, 360k	Std	Std
1	R2	Resistor, Chip, 1/16W, 1%, 180k	Std	Std
2	R3, R4	Resistor, Chip, 1/16W, 1%, 1.00M	Std	Std
1	U1	IC, Step-Down Converter, 3MHz, 1.6A, Low cost	TI	TLV62065DSG
2		Shunt, 100-mil, Black	3M	929950-00
1		PCB, 1.8 ln x 1.5 ln x 0.031 ln	Any	HPA719
1		Label (See note 5)	Brady	THT-13-457-10

## Notes:

- 1. These assemblies are ESD sensitive, ESD precautions shall be observed.
- 2. These assemblies must be clean and free from flux and all contaminants.

  Use of no clean flux is not acceptable.
- 3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
- 4. Ref designators marked with an asterisk ('\*\*') cannot be substituted.

  All other components can be substituted with equivalent MFG's components.
- 5. Install label after final wash. Text shall be 8 pt font. Text shall be per Table 1.

## Table 1

Assembly number	Text
HPA719-001	TLV62065EVM-719

# TIDA-00275 LP2998EVAL BOM

Quantity	Reference Designator	Description	Manufacturer	Part Number
1	PCB	LP2998EVAL bare board	TBD	SV600113
1	U1	IC CONV DDR DDR2 DDR3 8SOPWRPAD	TI	LP2998MRE/NOPB
1	C1	CAP CER 10000PF 6.3V 5% X7R 0805	AVX	08056C103JAZ2A
0	C2	Open		
0	C3	Open		
1	C4	330 uF, D3L, POSCAP, 6.3V	Panasonic	6TPE330MIL
1	C5	22 uF, 0805, X5R, 6.3V	Murata	GRM21BR60J226ME39L
1	C6	0.1 uF, 0805, X7R, 16V	Murata	GRM219R71C104KA01D
9	Test Points	Test Points	Cambion	160-1026-02-01-00

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